imall

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DMB53D0UV N-CHANNEL ENHANCEMENT MODE MOSFET PLUS NPN TRANSISTOR

Features

- N-Channel MOSFET and NPN Transistor in One Package
- Low On-Resistance
- Very Low Gate Threshold Voltage, 1.0V max
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- ESD Protected MOSFET Gate up to 2kV
- Lead, Halogen and Antimony Free, RoHS Compliant (Note 1)
- "Green" Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT563
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208
- Weight: 0.006 grams (approximate)





111

Bottom View



Top View Internal Schematic

B

F

Ordering Information (Note 3)

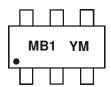
Part Number	Case	Packaging
DMB53D0UV-7	SOT563	3000/Tape & Reel
DMB53D0UV-13	SOT563	10000/Tape & Reel

SOT563

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. No purposely added lead. Halogen and Antimony free 2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com.

3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



 $\begin{array}{l} MB1 = Marking \ Code \\ YM = Date \ Code \ Marking \\ Y = Year \ (ex: V = 2008) \\ M = Month \ (ex: 9 = September) \end{array}$

Date Code Key

Year	2008	2009	20	10	2011	2012	2013	2014	20)15	2016	2017
Code	V	W	>	<	Y	Z	A	В	(С	D	E
									•			-
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings – MOSFET, Q1 @T_A = 25°C unless otherwise specified

Characteri	stic	Symbol	Value	Units
Drain-Source Voltage		V _{DSS}	50	V
Gate-Source Voltage		V _{GSS}	±12	V
Drain Current (Note 4)	Continuous	ID	160	mA
Pulsed Drain Current (Note 4)		I _{DM}	560	mA

Maximum Ratings - NPN Transistor, Q2 @TA = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	50	V
Collector-Emitter Voltage	V _{CEO}	45	V
Emitter-Base Voltage	V _{EBO}	6.0	V
Collector Current	Ιc	100	mA

Thermal Characteristics, Total Device @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 1)	PD	250	mW
Thermal Resistance, Junction to Ambient (Note 1)	R _{0JA}	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics - MOSFET @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
DFF CHARACTERISTICS (Note 5)							
Drain-Source Breakdown Voltage	BV _{DSS}	50	_	_	V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_		10	μA	$V_{DS} = 50V, V_{GS} = 0V$	
Gate-Body Leakage	I _{GSS}	_	_	1.0 5.0	μA	$V_{GS} = \pm 8V, V_{DS} = 0V$ $V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V _{GS(th)}	0.7	0.8	1.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	D	_	3.1	4	Ω	$V_{GS} = 4V, I_D = 100mA$	
Static Drain-Source On-Resistance	R _{DS (ON)}	_	4	5		$V_{GS} = 2.5V, I_D = 80mA$	
Forward Transconductance	g fs	180	_	_	mS	$V_{DS} = 10V, I_D = 100mA, f = 1.0KHz$	
DYNAMIC CHARACTERISTICS (Note 6)	-		•			-	
Input Capacitance	Ciss	_	25	_	pF	10111	
Output Capacitance	C _{oss}	_	5	_	pF	$V_{DS} = 10V, V_{GS} = 0V,$ = f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}	_	2.1	_	pF		

Notes: 4. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

5. Short duration pulse test used to minimize self-heating effect.

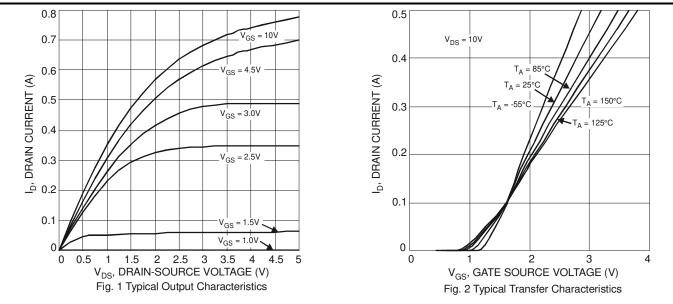
6. Guaranteed by design. Not subject to product testing.



Electrical Characteristics - NPN Transistor @T_A = 25°C unless otherwise specified

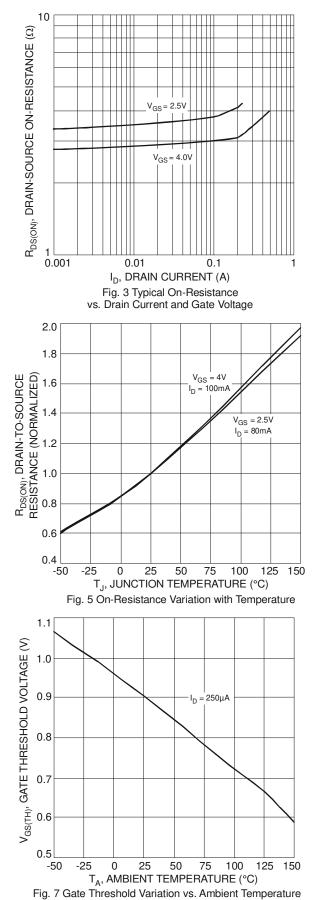
Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	(Note 5)	V _{(BR)CBO}	50	_	_	V	$I_{\rm C} = 10 \mu A, I_{\rm B} = 0$
Collector-Emitter Breakdown Voltage	(Note 5)	V _{(BR)CEO}	45	-	—	V	$I_{C} = 10 \text{mA}, I_{B} = 0$
Emitter-Base Breakdown Voltage	(Note 5)	V _{(BR)EBO}	6	-	—	V	$I_{E} = 1 \mu A, I_{C} = 0$
DC Current Gain	(Note 5)	h _{FE}	200	290	450	—	$V_{CE} = 5.0V, I_{C} = 2.0mA$
Collector-Emitter Saturation Voltage	(Note 5)	V _{CE(SAT)}		_	100 300	mV	$I_{C} = 10mA, I_{B} = 0.5mA$ $I_{C} = 100mA, I_{B} = 5.0mA$
Base-Emitter Saturation Voltage	(Note 5)	V _{BE(SAT)}		700 900	—	mV	$I_{C} = 10mA, I_{B} = 0.5mA$ $I_{C} = 100mA, I_{B} = 5.0mA$
Base-Emitter Voltage	(Note 5)	V _{BE}	580 —	660 —	700 770	mV	$V_{CE} = 5.0V, I_{C} = 2.0mA$ $V_{CE} = 5.0V, I_{C} = 10mA$
Collector-Cutoff Current	(Note 5)	I _{CBO} I _{CBO}		—	15 5.0	nA μA	V _{CB} = 30V V _{CB} = 30V, T _A = 150°C
Collector-Emitter Cut-Off Current	(Note 5)	ICES	_		100	nA	$V_{CE} = 45V$
Gain Bandwidth Product		f _T	100	—	—	MHz	$V_{CE} = 5.0V, I_{C} = 10mA, f = 100MHz$
Output Capacitance		C _{OBO}	_	—	4.5	pF	V _{CB} = 10V, f = 1.0MHz
Noise Figure		NF	_	—	10	dB	$\label{eq:VCE} \begin{split} V_{CE} &= 5V, \ R_S = 2.0 k\Omega, \\ f &= 1.0 kHz, \ BW = 200 Hz \end{split}$

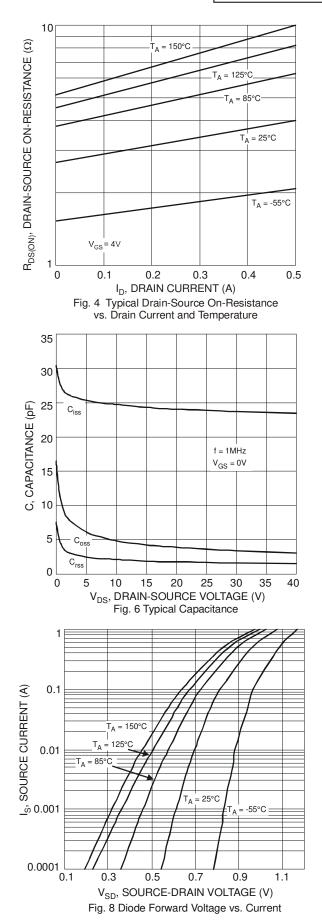
MOSFET





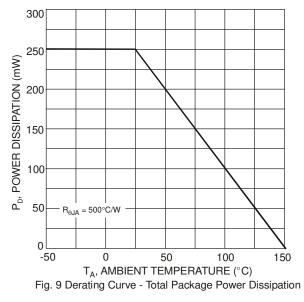


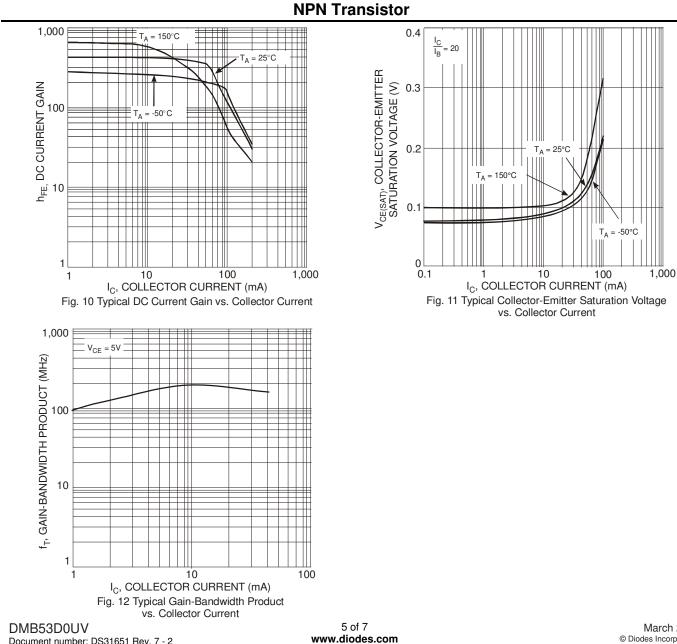






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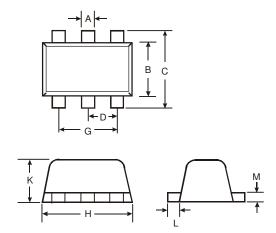




DMB53D0UV

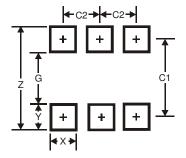


Package Outline Dimensions



SOT563							
Dim	Min	Max	Тур				
Α	0.15	0.30	0.20				
В	1.10	1.25	1.20				
С	1.55	1.70	1.60				
D	-	-	0.50				
G	0.90	1.10	1.00				
Н	1.50	1.70	1.60				
Κ	0.55	0.60	0.60				
L	0.10	0.30	0.20				
М	0.10	0.18	0.11				
All Dimensions in mm							

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.2
G	1.2
Х	0.375
Y	0.5
C1	1.7
C2	0.5



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